

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

 Series/Type:
 B32674 ... B32678

 Date:
 June 2013

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Metallized polypropylene film capacitors (MKP)

MKP DC link - high power series

B32674 ... B32678

Typical applications

For high ripple current modules in:

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1): 40/100/56

Construction

- Dielectric: metallized polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Excellent self-healing properties
- Over-voltage capability
- Optimized electrical contact
- High frequency ripple current
- High reliability
- Long useful life
- RoHS-compatible
- Halogen-free capacitors available on request

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin versions
- Standard lead lengths: 6 -1 mm
- Special lead lengths are available on request

Marking

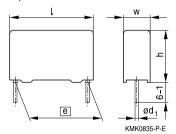
Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage

Delivery mode

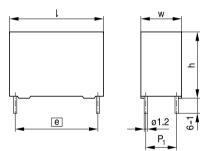
Bulk (untaped, lead length 6 -1 mm)

Dimensional drawings

2-pin version







KMK1064-2

Dimensions in mm

Version	Lead spacing <i>e</i> _±0.4	Lead diameter d ₁	Туре
2-pin	27.5	0.8	B32674D
2-pin	37.5	1.0	B32676T
4-pin	37.5	1.2	B32676G
4-pin	52.5	1.2	B32678G



MKP

B32674 ... B32678

MKP DC link – high power series

Overview of available types

Lead spacing	27.5 mm										
Туре	B32674										
Page	6	3									
V _R (V DC)	300	450	630	750	875						
C _R (μF)											
0.47											
0.68											
1.0											
1.5											
2.2											
3.0											
3.3											
4.0											
4.7											
5.0											
5.6											
6.0											
6.8											
7.5											
8.0											
8.2											
10											
12											





MKP DC link – high power series

Lead spacing	37.5 mm				
Туре	B32676				
Page	8				
V _R (V DC)	300	450	630	750	875
C _R (μF)					
1.5					
2.0					
2.7					
3.3					
3.5					
4.0					
4.7					
5.6					
6.2					
6.8					
7.5					
8.2					
9.0					
10					
12 14					
14					
15					
20					
22					
25					
30					
35					



MKP

B32674 ... B32678

MKP DC link – high power series

Lead spacin	g 52.5 mm				
Туре	B32678				
Page	10				
V _R (V DC)	300	450	630	750	875
C _R (μF)					
15					
20					
25					
30					
35					
40					
47					
60					



MKP DC link – high power series

Ordering codes and packing units (lead spacing 27.5 mm)

$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Straight terminals, Untaped pcs./MOQ 1280 1120 1040 960 960 800
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Untaped pcs./MOQ 1280 1120 1040 960 960 800
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	pcs./MOQ 1280 1120 1040 960 960 800
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	1280 1120 1040 960 960 800
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	1120 1040 960 960 800
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	1120 1040 960 960 800
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	1040 960 960 800
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	960 960 800
5.6 15.0×24.5×31.5 – B32674D3565+000 11.5 10.5 3.9 9	960 800
	800
$0.0 10.0 \times 27.5 \times 31.5 - 0.000 0.000 12.5 11.5 0.7$	
8.0 16.0 × 32.0 × 31.5 - B32674D3805+000 13.5 12.5 3.4 8	880
	800
	800 720
	720 640
	640
$V_{R,85\ C} = 450\ V\ DC,\ V_{op,70\ C} = 630\ V\ DC$	
	1280
	1120
3.3 15.0 × 24.5 × 31.5 – B32674D4335+000 9.5 8.5 5.2 9	960
	800
5.0 16.0 × 32.0 × 31.5 - B32674D4505+000 12.0 11.0 5.0 8	880
5.6 18.0 × 33.0 × 31.5 – B32674D4565+000 12.5 11.0 4.4 8	800
6.0 21.0 × 31.0 × 31.5 – B32674D4605+000 13.0 11.5 4.3	720
6.8 22.0 × 36.5 × 31.5 – B32674D4685+000 14.0 12.5 4.0 (640
7.5 22.0 × 36.5 × 31.5 – B32674D4755+000 15.0 13.0 3.9 (640
$V_{R,85 ^{\circ}C} = 630 \text{V DC}, V_{op,70 ^{\circ}C} = 800 \text{V DC}$	
1.0 11.0 × 19.0 × 31.5 - B32674D6105+000 5.0 4.5 14.4 12	1280
1.5 12.5 × 21.5 × 31.5 – B32674D6155+000 6.5 6.0 14.3 1	1120
2.2 15.0 × 24.5 × 31.5 – B32674D6225+000 7.0 6.0 8.0 9	960
3.3 16.0 × 32.0 × 31.5 – B32674D6335+000 7.0 6.0 6.5 8	880
4.7 22.0 × 36.5 × 31.5 – B32674D6475+000 9.5 9.5 5.8 6	640
5.0 22.0 × 36.5 × 31.5 – B32674D6505+000 10.5 9.5 5.8 6	640

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $\begin{array}{l} \mathsf{K}=\pm10\%\\ \mathsf{J}=\pm5\% \end{array}$

Please read *Cautions and warnings* and *Important notes* at the end of this document.



MKP DC link - high power series

MKP → 27.5 ◄

Ordering codes and packing units (lead spacing 27.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{typ}	Straight
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	terminals,
			below)	10 kHz	20 kHz	10 kHz	Untaped
μF	mm	mm		А	А	mΩ	pcs./MOQ
V _{R,85} ∘ _C =	= 750 V DC, V _{op,70 °C} =	900	V DC				
0.68	$11.0\times19.0\times31.5$	-	B32674D1684+000	5.0	4.5	23.3	1280
1.0	$12.5\times21.5\times31.5$	_	B32674D1105+000	6.0	5.5	12.4	1120
1.5	$14.0\times24.5\times31.5$	_	B32674D1155+000	7.5	6.0	9.5	1040
2.2	$18.0\times27.5\times31.5$	_	B32674D1225+000	9.0	7.5	6.6	800
3.3	$21.0\times31.0\times31.5$	—	B32674D1335+000	10.0	9.0	6.0	720
4.0	$22.0\times36.5\times31.5$	-	B32674D1405+000	11.0	10.0	5.6	640
V _{R,85} ° _C =	= 875 V DC, V _{op,70 °C} =	1050	V DC				
0.47	$11.0\times19.0\times31.5$	_	B32674D8474+000	5.0	4.5	22.9	1280
0.68	$11.0 \times 21.0 \times 31.5$	—	B32674D8684+000	6.0	5.5	18.6	1280
1.0	$13.5 \times 23.0 \times 31.5$	_	B32674D8105+000	7.5	6.0	13.6	1040
1.5	$18.0\times27.5\times31.5$	_	B32674D8155+000	7.0	6.5	8.5	800
2.2	$18.0\times33.0\times31.5$	—	B32674D8225+000	10.0	9.0	5.1	800
3.0	$22.0\times36.5\times31.5$	-	B32674D8305+000	11.0	10.0	6.8	640

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

- + = Capacitance tolerance code:
 - $K = \pm 10\%$

 $J = \pm 5\%$



MKP DC link - high power series

Ordering codes and packing units (lead spacing 37.5 mm)

C _R	Max. dimensions	P₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{tvp}	Straight
-1	w×h×l		(composition see	70 °C	70 °C	70 °C	terminals,
			below)	10 kHz	20 kHz	10 kHz	Untaped
μF	mm	mm		A	A	mΩ	pcs./MOQ
·	= 300 V DC, V _{op,70 °C} =		V DC	1	1	[···	
			-	0.5	0.5	0.0	10.10
6.2	24.0 × 15.0 × 41.5	-	B32676T3625+000	9.5	9.5	6.0	1040
9	24.0 × 19.0 × 41.5	-	B32676T3905K000	11.0	10.5	4.5	780
15	$20.0\times39.5\times42.0$	10.2	B32676G3156+000	15.0	14.0	3.2	640
20	$28.0\times37.0\times42.0$	10.2	B32676G3206+000	15.5	14.5	2.7	440
22	$28.0\times42.5\times42.0$	10.2	B32676G3226+000	16.0	15.0	2.6	440
25	$28.0\times42.5\times42.0$	10.2	B32676G3256+000	16.5	15.5	2.4	440
30	$30.0\times45.0\times42.0$	20.3	B32676G3306+000	17.0	16.0	2.3	400
35	$33.0 \times 48.0 \times 42.0$	20.3	B32676G3356+000	18.0	17.0	1.5	192
V _{R,85} ° _C =	= 450 V DC, V _{op,70 °C} =	630	V DC				
4.0	$24.0\times15.0\times41.5$	-	B32676T4405+000	8.5	8.5	7.0	1040
4.7	$24.0\times9.0\times41.5$	-	B32676T4475+000	9.5	9.0	7.0	780
8.2	$20.0\times39.5\times42.0$	10.2	B32676G4825+000	11.5	10.0	8.8	640
10	$20.0\times39.5\times42.0$	10.2	B32676G4106+000	12.5	11.0	7.3	640
15	28.0 imes 42.5 imes 42.0	10.2	B32676G4156+000	14.0	13.0	5.0	440
20	$30.0 \times 45.0 \times 42.0$	20.3	B32676G4206K000	16.0	15.0	4.0	400
25	$33.0 \times 48.0 \times 42.0$	20.3	B32676G4256K000	18.0	17.0	1.5	192
V _{R,85 °C} =	= 630 V DC, V _{op,70 °C} =	800	V DC			•	•
2.7	$24.0 \times 15.0 \times 41.5$	_	B32676T6275+000	8.0	8.0	8.0	1040
3.5	$24.0 \times 19.0 \times 41.5$	_	B32676T6355+000	9.0	9.0	7.0	780
6.8	$20.0 \times 39.5 \times 42.0$	10.2	B32676G6685+000	10.0	9.5	7.1	640
7.5	$20.0 \times 39.5 \times 42.0$	10.2	B32676G6755+000	10.0	9.5	6.7	640
8.2	$28.0 \times 37.0 \times 42.0$	10.2	B32676G6825+000	10.5	10.0	6.2	440
10	$28.0 \times 42.5 \times 42.0$	10.2	B32676G6106+000	11.0	10.5	5.7	440
12	$28.0 \times 42.5 \times 42.0$	10.2	B32676G6126+000	11.5	11.0	5.5	440
14	$30.0 \times 45.0 \times 42.0$	20.3	B32676G6146+000	12.0	11.5	3.6	400
15	$33.0 \times 48.0 \times 42.0$	20.3	B32676G6156+000	15.0	14.0	2.3	192
10	00.0 A 40.0 A 42.0	20.0	D0207 000100+000	10.0	14.0	2.0	102

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ $J = \pm 5\%$



MKP DC link – high power series

MKP → 37.5 ←

Ordering codes and packing units (lead spacing 37.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{typ}	Straight
	$w \times h \times I$		(composition see	70 °C	70 °C	70 °C	terminals,
			below)	10 kHz	20 kHz	10 kHz	Untaped
μF	mm	mm		А	А	mΩ	pcs./MOQ
V _{R,85 °C} =	= 750 V DC, V _{op,70 °C} =	900	V DC				
2.0	$24.0 \times 15.0 \times 41.5$	-	B32676T1205+000	7.5	7.5	10.0	1040
2.7	$24.0\times19.0\times41.5$	—	B32676T1275+000	8.5	8.5	8.0	780
4.7	$20.0\times39.5\times42.0$	10.2	B32676G1475+000	11.0	10.0	7.8	640
5.6	$20.0\times39.5\times42.0$	10.2	B32676G1565+000	11.5	10.5	7.1	640
6.8	$28.0\times37.0\times42.0$	10.2	B32676G1685+000	12.5	11.5	6.7	440
9.0	$30.0 \times 45.0 \times 42.0$	20.3	B32676G1905+000	14.0	13.0	6.0	440
10	$30.0 \times 45.0 \times 42.0$	20.3	B32676G1106+000	15.0	14.0	5.8	400
12	$33.0 \times 48.0 \times 42.0$	20.3	B32676G1126+000	19.5	19.0	2.7	192
V _{R,85 °C} =	= 875 V DC, V _{op,70 °C} =	1050	V DC				
1.5	$24.0\times15.0\times41.5$	-	B32676T8155+000	7.0	7.0	12.0	1040
2.0	$24.0\times19.0\times41.5$	—	B32676T8205+000	8.0	7.5	9.0	780
3.3	$20.0\times39.5\times42.0$	10.2	B32676G8335+000	11.0	10.0	11.0	640
4.0	$20.0\times39.5\times42.0$	10.2	B32676G8405+000	11.5	10.5	9.8	640
4.7	$28.0\times37.0\times42.0$	10.2	B32676G8475+000	12.5	11.5	8.6	440
6.8	$28.0\times42.5\times42.0$	10.2	B32676G8685+000	14.0	13.0	8.3	440
7.5	$30.0 \times 45.0 \times 42.0$	20.3	B32676G8755+000	15.0	14.0	8.0	400
10	$33.0\times48.0\times42.0$	20.3	B32676G8106K000	19.5	19.0	3.7	192

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$

 $J = \pm 5\%$

⇔TDK



MKP DC link – high power series

B32678

Ordering codes and packing units (lead spacing 52.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{typ}	Straight
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	terminals,
			below)	10 kHz	20 kHz	10 kHz	Untaped
μF	mm	mm		А	А	mΩ	pcs./MOQ
V _{R,85} ° _C =	= 300 V DC, V _{op,70 °C} =	450	V DC				
40	$30.0 \times 45.0 \times 57.5$	20.3	B32678G3406+000	19.0	18.0	1.9	280
47	$35.0\times50.0\times57.5$	20.3	B32678G3476+000	21.0	20.0	1.7	108
60	$35.0\times50.0\times57.5$	20.3	B32678G3606K000	23.0	22.0	1.6	108
V _{R,85} ° _C =	= 450 V DC, V _{op,70 °C} =	630	V DC				
30	$35.0\times50.0\times57.5$	20.3	B32678G4306+000	19.5	18.5	2.1	108
35	$35.0\times50.0\times57.5$	20.3	B32678G4356+000	21.0	20.0	1.7	108
40	$35.0\times50.0\times57.5$	20.3	B32678G4406K000	22.0	21.0	1.5	108
V _{R,85} ° _C =	= 630 V DC, V _{op,70 °C} =	800 8	V DC				
20	$35.0\times50.0\times57.5$	20.3	B32678G6206+000	17.5	16.5	2.9	108
25	$35.0\times50.0\times57.5$	20.3	B32678G6256+000	20.0	19.0	2.6	108
V _{R,85} ° _C =	= 750 V DC, V _{op,70 °C} =	= 900	V DC				
15	$30.0\times45.0\times57.5$	20.3	B32678G1156K000	20.0	19.5	3.7	280
20	$35.0\times50.0\times57.5$	20.3	B32678G1206K000	21.0	20.0	2.6	108
V _{R,85} ° _C =	875 V DC, V _{op,70 °C} =	1050	V DC				
15	$35.0\times50.0\times57.5$	20.3	B32678G8156K000	21.0	20.0	3.4	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$

 $J = \pm 5\%$



MKP DC link – high power series

MKP

Technical data

Reference standard: IEC 61071. All data given at T = 20 °C, unless otherwise specified.

Operating temperature range (case	Max. operating temperature, T _{op,max} +105 °C
	Upper category temperature T _{max} +100 °C
	Lower category temperature T _{min} -40 °C
ESR (at 10 kHz) LS 27.5	$< 3.0 \cdot \text{ESR}_{typ}$
LS 37.5	$< 2.5 \cdot \text{ESR}_{typ}$
LS 52.5	$< 1.5 \cdot \text{ESR}_{typ}$
Insulation Resistance R _{ins}	30 000 s
given as time constant	
t= $C_R \cdot R_{ins}$, rel. humidity $\leq 65\%$	
(minimum as-delivered values)	
DC test voltage between terminals	10 s) 1.5 · V _R
DC test voltage terminal to case (10	s) 2110 V AC, 50 Hz
Maximum peak current (A)	$\mathbf{I}_{P,max} = \mathbf{C}_{R} \cdot \frac{d V}{d t}$
Damp heat test	56 days/40 °C/93% relative humidity
Limit values after damp heat test	Capacitance change $\Delta C/C$ $\leq 5\%$
	Dissipation factor change Δ tan $\delta \leq 1.5 \cdot 10^{-3}$ (at 1 kHz)
	Insulation resistance $R_{ins} \ge 50\%$ of minimum
	as-delivered values
Reliability: Failure rate	λ 1 fit (≤ 1 · 10 ⁻⁹ /h) at 0.5 · V _B , 40 °C
Service life	t _{st} 200 000 h at V _B , 85 °C
	For conversion to other operating conditions and
	temperatures, refer to chapter "Quality, 2 Reliability".
V _B (V DC)	300 450 630 750 875
Continuous operation voltage	
V _{op} (V DC) at 70 °C	450 630 800 900 1050
Continuous operation voltage	
V _{op} (V DC) at 85 °C	300 450 630 750 875
Maximum peak voltage	
V _{P,max} (V DC)	450 675 950 1125 1300
For temperatures between	
85 °C and 100 °C	1.2%/°C of derating respect V _{op} at 85 °C





Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

Note:

The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor. These parameters are given for isolated pulses in such a way that the heat generated by one pulse will be completely dissipated before applying the next pulse. For a train of pulses, please refer to the curves of permissible AC voltage-current versus frequency.

dV/dt values

Lead spacing	27.5 mm				37.5 mm				52.5 mm						
Туре	B326	674				B326	676				B326	678			
V _R (V DC)	300	450	630	750	875	300	450	630	750	875	300	450	630	750	875
dV/dt in V/µs	40	75	100	125	150	22	54	73	85	100	15	35	50	60	70



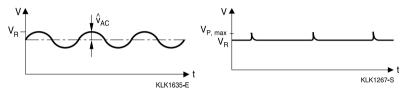
В32674 ... В32678 МКР

MKP DC link – high power series

ESL values

	ESL
2-pin	25 nH
4-pin	17 nH

Typical waveforms



Restrictions:

 V_{R} : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

 $\hat{v}_{AC} \leq 0.2 \cdot V_{R}$

 $V_{P, max}$: Maximum permissible recurrent voltage that may appear for 2% of the period.





Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

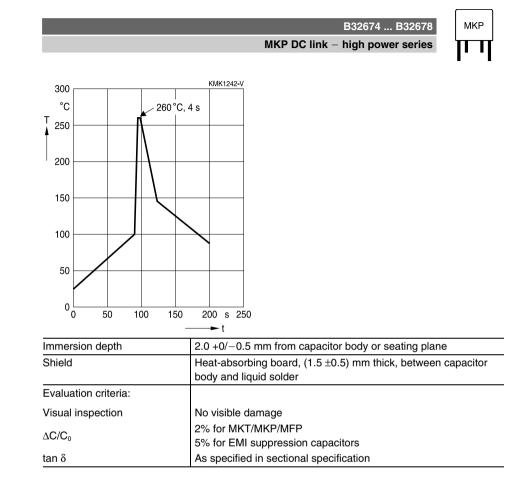
Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/ -0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder \ge 90%, free-flowing solder

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5±1 s
МКР МКТ	(lead spacing \leq 7.5 mm) uncoated (lead spacing \leq 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing \leq 10 mm) and insulated (B32559)

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MKP DC link – high power series

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



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Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



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Торіс	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"



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Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α _c	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β _c	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
		Wechselspannung
f ₂	Frequency limit for reducing permissible	Grenzfrequenz für strombedingte
	AC voltage due to current limit	Reduzierung der zulässigen
		Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F⊤	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _c	Category current (max. continuous	Kategoriestrom (max. Dauerstrom)
-	current)	



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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i _z	Capacitance drift	Inkonstanz der Kapazität
k ₀	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
-	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P _{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
Ri	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _₽	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ _P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
$tan \delta_s$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Ambient temperature	Umgebungstemperatur
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{oL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T _{op}	Operating temperature	Beriebstemperatur
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer
V _{AC}	AC voltage	Wechselspannung



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Symbol	English	German
V _c	Category voltage	Kategoriespannung
V _{C,RMS}	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V _R	Rated voltage	Nennspannung
ν _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{sc}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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